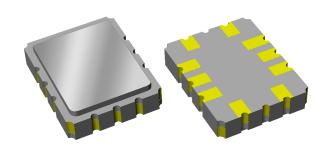


# **Applications**

• For WCDMA applications



## Product Features

- Usable bandwidth 25 MHz
- Low loss
- High attenuation
- Low EVM
- Balanced operation
- Ceramic Surface Mount Package (SMP-28C)
- Small Size: 7.00 x 5.50 x 1.24 mm
- Hermetically Sealed
- **RoHS** compliant (2002/95/EC), **Pb**-free (**Pb**)



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- 1 of 6 -

## **General Description**

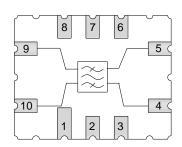
The 857072 is a high-performance IF SAW filter with a center frequency of 242.5 and minimum 1.0 dB bandwidth of 25 MHz

It features low loss with excellent attenuation, and is designed to be used with a balanced input and output. The small size of this surface mounted filter makes it an economical choice for demanding applications such as WCDMA or other similar high data rate communications standards.

This device is RoHS compliant and Pb-free.

## Functional Block Diagram

Top view



# **Pin Configuration**

Pin # Bal/Bal	Description
10	Input +
9	Input -
5	Output +
4	Output -
1,2,3	Case Ground
6,7,8	Case Ground

# Ordering Information

Part No.	Description
857072	packaged part
857072-EVB	evaluation board

Standard T/R size = 3000 units/reel.



# **Specifications**

# Electrical Specifications (1, 2)

Specified Temperature Range: (3) +10 to +75 °C

Parameter (4)	Conditions	Min	Typical (5)	Max	Units
Center Frequency	f <sub>o</sub>	-	242.5	-	MHz
Insertion Loss	at 242.5 MHz	-	9	10.5	dB
1.0 dB Bandwidth <sup>(10)</sup>		25	27.6	-	MHz
2.0 dB Lower Band edge <sup>(9)</sup>		-	228.7	230	MHz
2.0 dB Upper Band edge <sup>(9)</sup>		255	256.8	-	MHz
35 dB Bandwidth <sup>(10)</sup>		-	32.2	35.5	MHz
Pass Band Flatness <sup>(7)</sup>	230 – 255 MHz	-	0.4	1.0	dB
Absolute Delay	over f <sub>o</sub> +/- 12.5 MHz	-	0.67	0.70	μs
Group Delay Ripple <sup>(6)</sup>	over f <sub>o</sub> +/- 12.5 MHz	-	30	60	ns p-p
Group Delay Ripple <sup>(6)</sup>	Any 3.84 MHz channel over f <sub>o</sub>	-	29	50	ns p-p
	+/- 12.5 MHz				
EVM (8)	Any 3.84 MHz channel over f <sub>o</sub>	-	1.2	2	%
	+/- 12.5 MHz				
Temperature Coefficient		-	-94	-	ppm/ °C
Input Return Loss	over f <sub>o</sub> +/- 12.5 MHz	8.5	12	-	dB
Output Return Loss	over f <sub>o</sub> +/- 12.5 MHz	8.5	19	-	dB
Stopband Attenuation <sup>(10)</sup>	5 – 25 MHz	40	46	-	dB
-	25 – 100 MHz	45	50	-	dB
	100 – 225 MHz	35	42	-	dB
	260 – 260.7 MHz	26	36	-	dB
	260.7 – 310 MHz	35	38	-	dB
	310 – 500 MHz	40	53	-	dB
Source/Load Impedance (balanced) (11)		-	100	-	Ω

#### Notes:

- 1. All specifications are based on the TriQuint schematic for the main reference design shown on page 3
- 2. An external impedance matching network with ±2% tolerance will be necessary to achieve the proposed specifications
- In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
- 4. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
- 5. Typical values are based on average measurements at room temperature
- 6. This ripple is defined as the worst peak to adjacent valley within specified frequency range
- 7. Passband Flatness is defined as the difference between maximum and minimum loss over the specified band
- 8. The EVM specification is guaranteed by design and measured approximately in production
- 9. 2.0 db Band edges are relative to Minimum Loss
- 10. All Bandwidth and Attenuation measurements are relative to loss at 1dB Center Frequency
- 11. This is the optimum impedance in order to achieve the performance shown

# **Absolute Maximum Ratings**

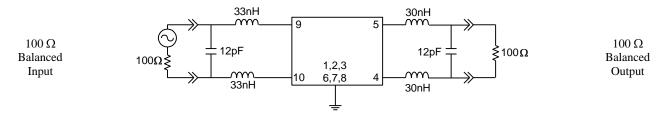
(Operation of this device outside the parameter ranges given above may cause permanent damage)

Parameter	Rating
Operable /Storage Temperature	-40 to +85 °C
Input Power	+10dBm (Measured with continuous sine wave signal. Expected lifetime of greater than or equal to 10K Hrs at 55 °C)



# Reference Design – $100\Omega$ Bal Input, $100\Omega$ Bal Output

#### **Schematic**



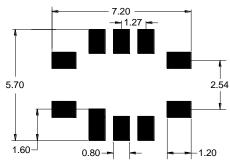
Notes:

1. Actual matching values may vary due to PCB layout and parasitic

## **PC Board**

# 960686 L1 L3 C2 L4

# **Mounting Configuration**



Notes:

Top, middle & bottom layers: 1 oz copper Substrates: FR4 dielectric, .031" thick

Finish plating: Nickel: 3-8µm thick, Gold: .03-.2µm thick

Hole plating: Copper min .0008µm thick

#### Notes:

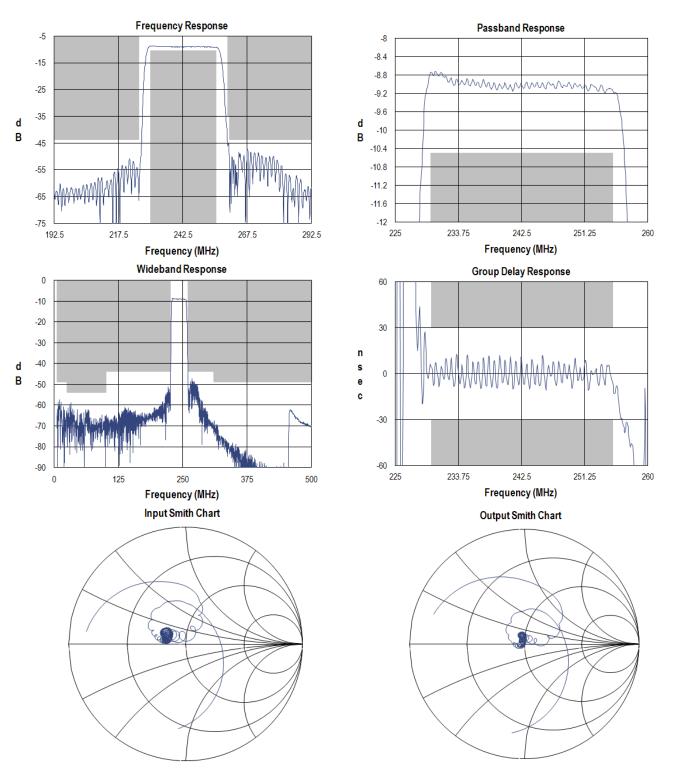
- 1. All dimensions are in millimeters.
- 2. This footprint represents a recommendation only.

#### **Bill of Material**

Reference Desg.	Value	Description	Manufacturer	Part Number
L1	33nH	Coil Wire-wound, 0603 5%	MuRata	LQW18AN33NJ00
L2	33nH	Coil Wire-wound, 0603, 5%	MuRata	LQW18AN33NJ00
L3	30nH	Coil Wire-wound, 0603, 5%	MuRata	LQW18AN30NJ00
L4	30nH	Coil Wire-wound, 0603, 5%	MuRata	LQW18AN30NJ00
C1	12pF	Chip Ceramic, 0603, 5%	MuRata	GRM1885C1H120JA01
C2	12pF	Chip Ceramic, 0603, 5%	MuRata	GRM1885C1H120JA01
SMA	N/A	SMA connector	Johnson Components	142-0701-801
PCB	N/A	3-layer	multiple	960686



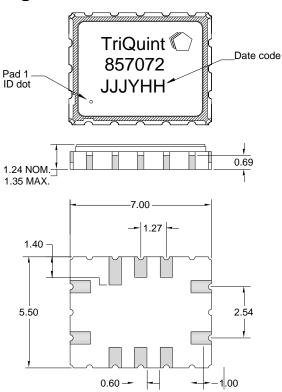
# Typical Performance (at room temperature)





## **Mechanical Information**

# **Package Information, Dimensions and Marking**



Package Style: SMP-28C

Dimensions: 7.00 x 5.50 x 1.24 mm

Body:  $Al_2O_3$  ceramic Lid: Kovar, Ni plated

Terminations: Au plating 0.5 - 1.0μm, over a 2-6μm Ni

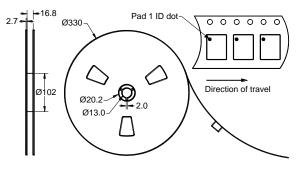
plating

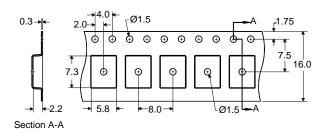
All dimensions shown are nominal in millimeters All tolerances are  $\pm 0.15 mm$  except overall length and width  $\pm 0.10 mm$ 

The date code consists of: day of the current year (Julian, 3 digits), Y = last digit of the year (1 digit), and HH = hour (2 digits)

# **Tape and Reel Information**

Standard T/R size = 3000 units/reel. All dimensions are in millimeters







## **Product Compliance Information**

#### **ESD Information**



### **Caution! ESD-Sensitive Device**

ESD Rating: 1A

Value: Passes  $\geq 250$ V min.

Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

ESD Rating: B

Value: Passes ≥ 200V min. Test: Machine Model (MM)

Standard: JEDEC Standard JESD22-A115

# **MSL Rating**

Devices are Hermetic, therefore MSL is not applicable

# **Solderability**

Compatible with the latest version of J-STD-020, lead free solder, 260°C

Refer to **Soldering Profile** for recommended guidelines.

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A  $(C_{15}H_{12}Br_4O_2)$  Free
- PFOS Free
- SVHC Free

## **Contact Information**

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